



US00D733662S

(12) **United States Design Patent**  
**Harper, Jr. et al.**

(10) **Patent No.:** **US D733,662 S**  
(45) **Date of Patent:** **\*\* Jul. 7, 2015**

(54) **CONNECTOR HOUSING FOR ELECTRICAL CONNECTOR**

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(\*\*) Term: **14 Years**

(21) Appl. No.: **29/498,233**

(22) Filed: **Aug. 1, 2014**

**Related U.S. Application Data**

(62) Division of application No. 29/444,125, filed on Jan. 25, 2013.

(51) **LOC (10) Cl.** ..... **13-03**

(52) **U.S. Cl.**  
USPC ..... **D13/147**

(58) **Field of Classification Search**  
USPC ..... D13/133, 146, 147, 154, 184, 199;  
439/74, 108, 180, 246, 252, 258, 278,  
439/374, 378, 379, 381, 527, 529, 533, 660,  
439/717, 865-894, 953; 174/16.3; 257/697,  
257/727; 361/769

See application file for complete search history.

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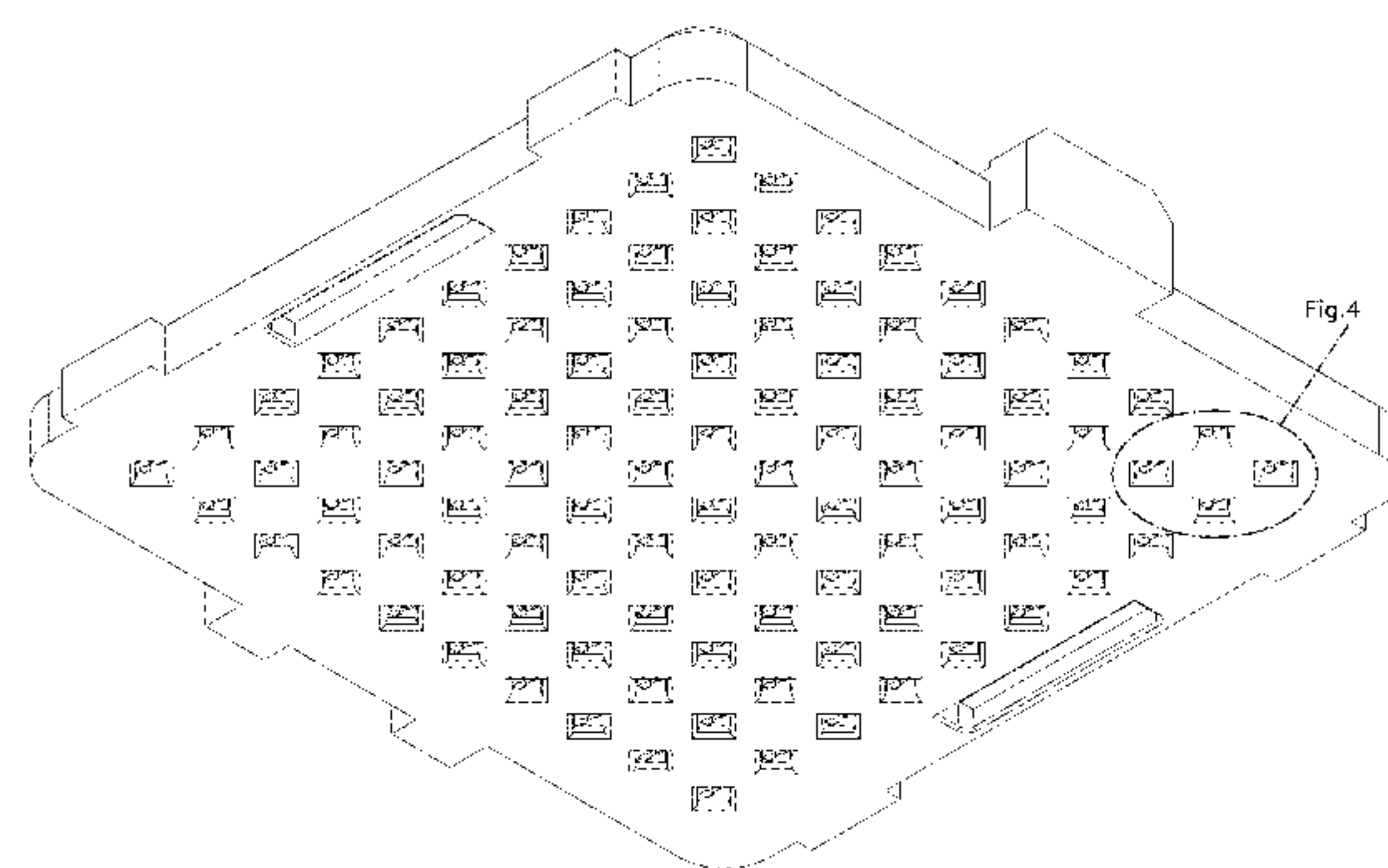
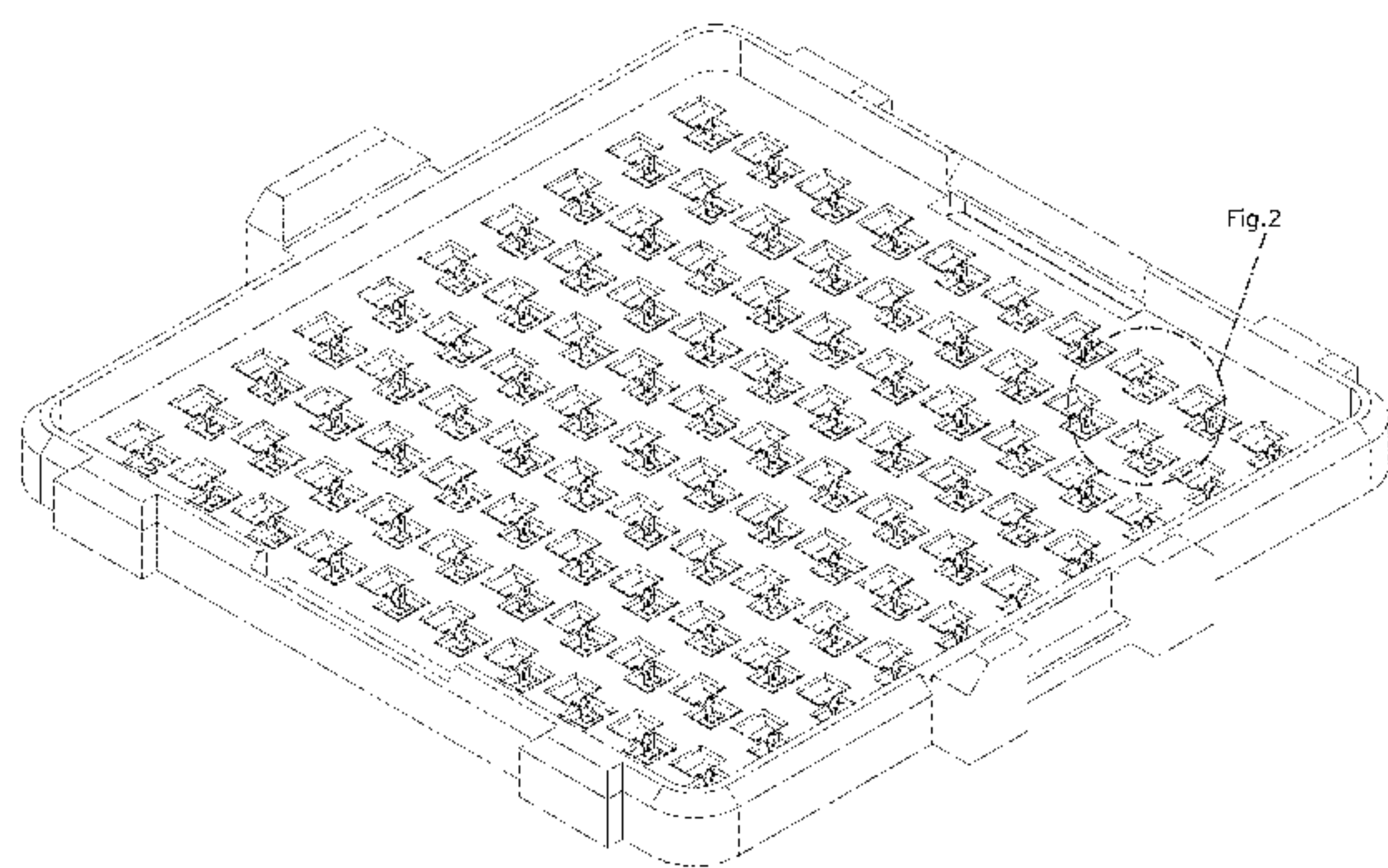
(57) **CLAIM**

The ornamental design for a connector housing for an electrical connector, as shown and described.

**DESCRIPTION**

FIG. 1 is a top, left, front perspective view of a connector housing for an electrical connector according to one embodiment of our design;  
FIG. 2 is an enlarged region of the top, left, front perspective view thereof as illustrated in FIG. 1, taken at Line 2;  
FIG. 3 is a bottom, right, rear perspective view thereof;  
FIG. 4 is an enlarged region of the bottom, right, rear perspective view thereof as illustrated in FIG. 3, taken at Line 4;  
FIG. 5 is a bottom, left, front perspective view thereof;  
FIG. 6 is an enlarged region of the bottom, left, front perspective view thereof as illustrated in FIG. 5, taken at Line 6;  
FIG. 7 is a top, left, rear perspective view thereof;  
FIG. 8 is an enlarged region of the top, left, rear perspective view thereof as illustrated in FIG. 7, taken at Line 8;  
FIG. 9 is a left side elevation view thereof;  
FIG. 10 is a right side elevation view thereof;  
FIG. 11 is a front elevation view thereof;  
FIG. 12 is a rear elevation view thereof;  
FIG. 13 is a bottom plan view thereof; and,  
FIG. 14 is a top plan view thereof.

**1 Claim, 10 Drawing Sheets**





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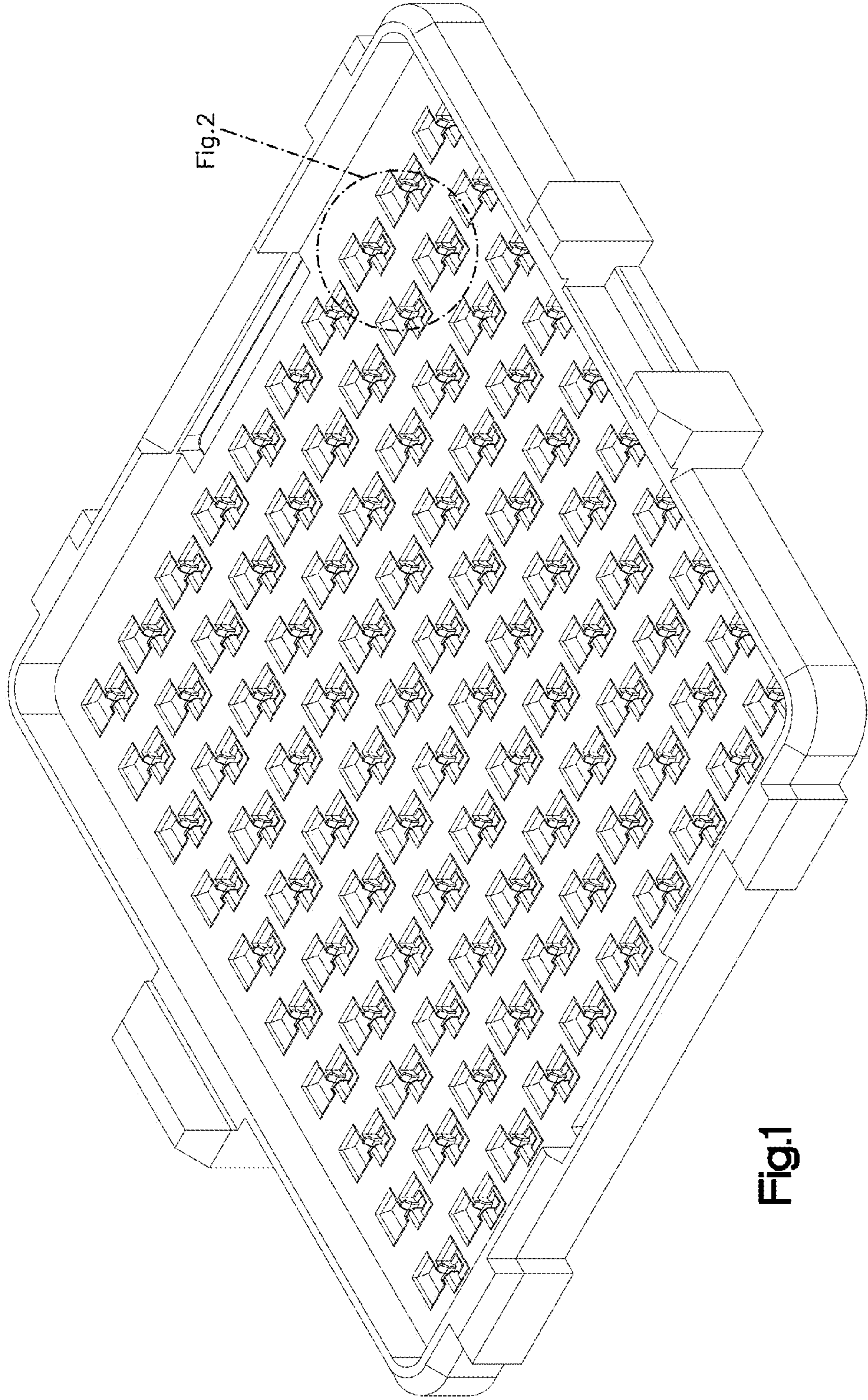
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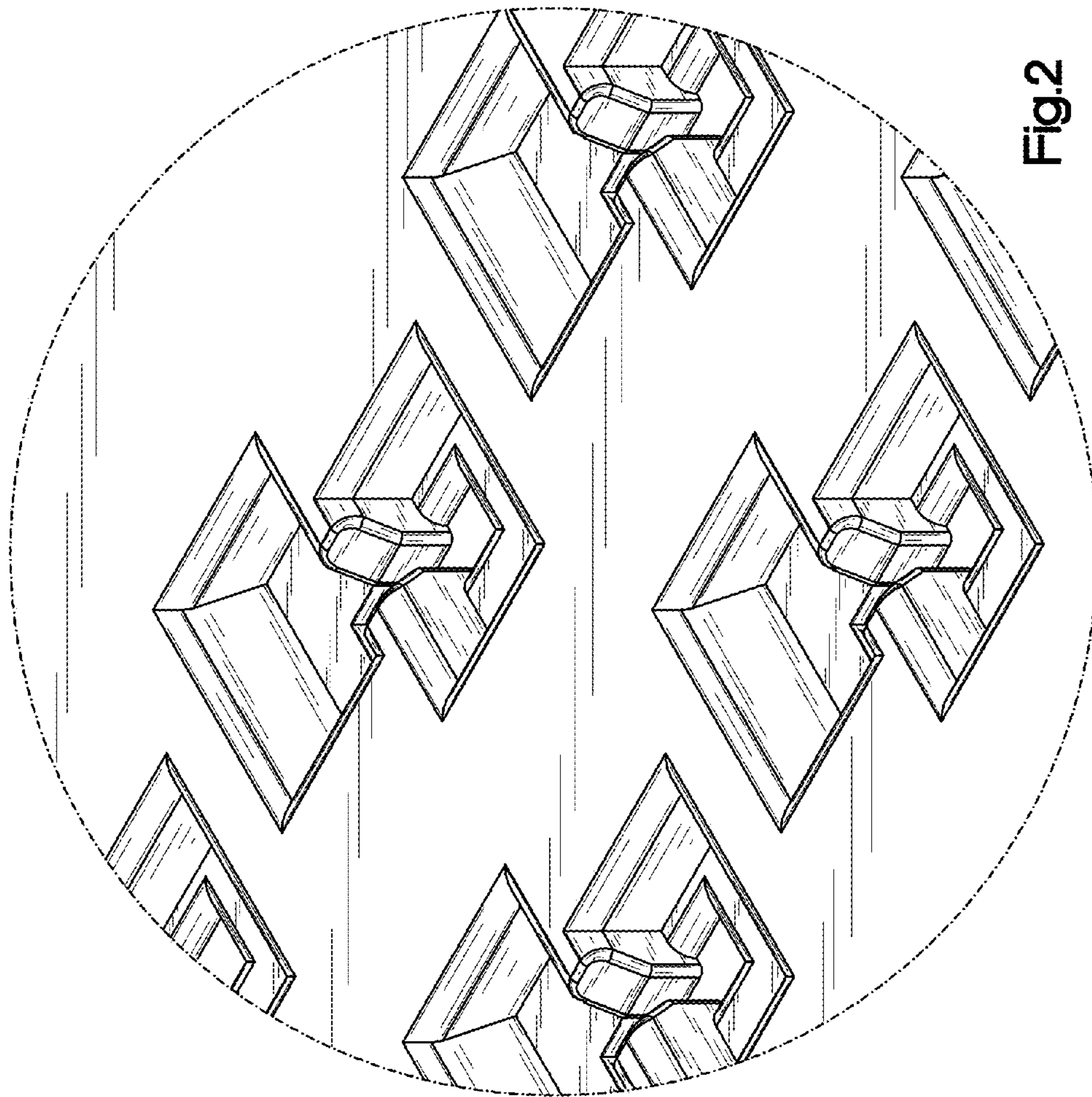


Fig. 2



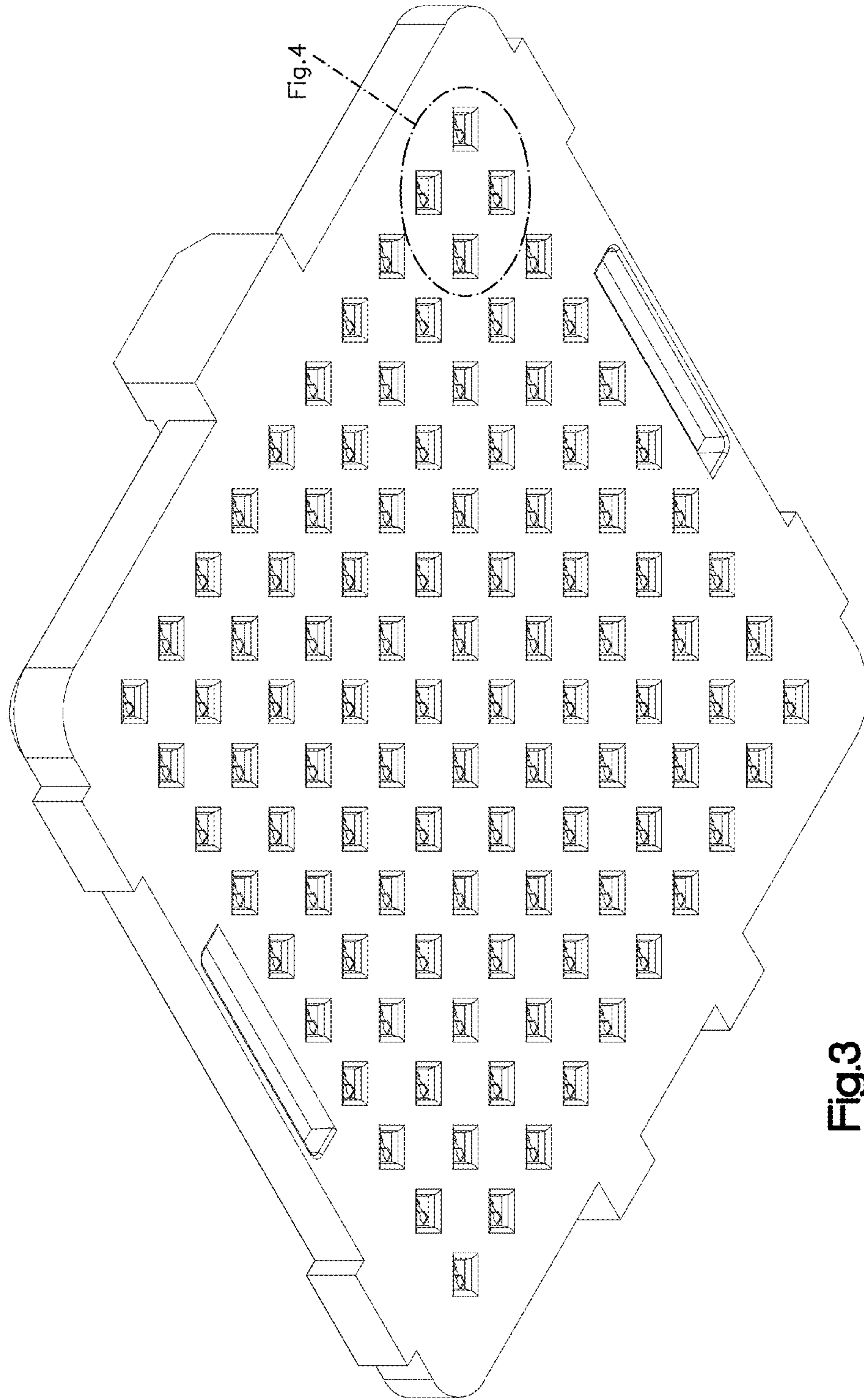


Fig.3



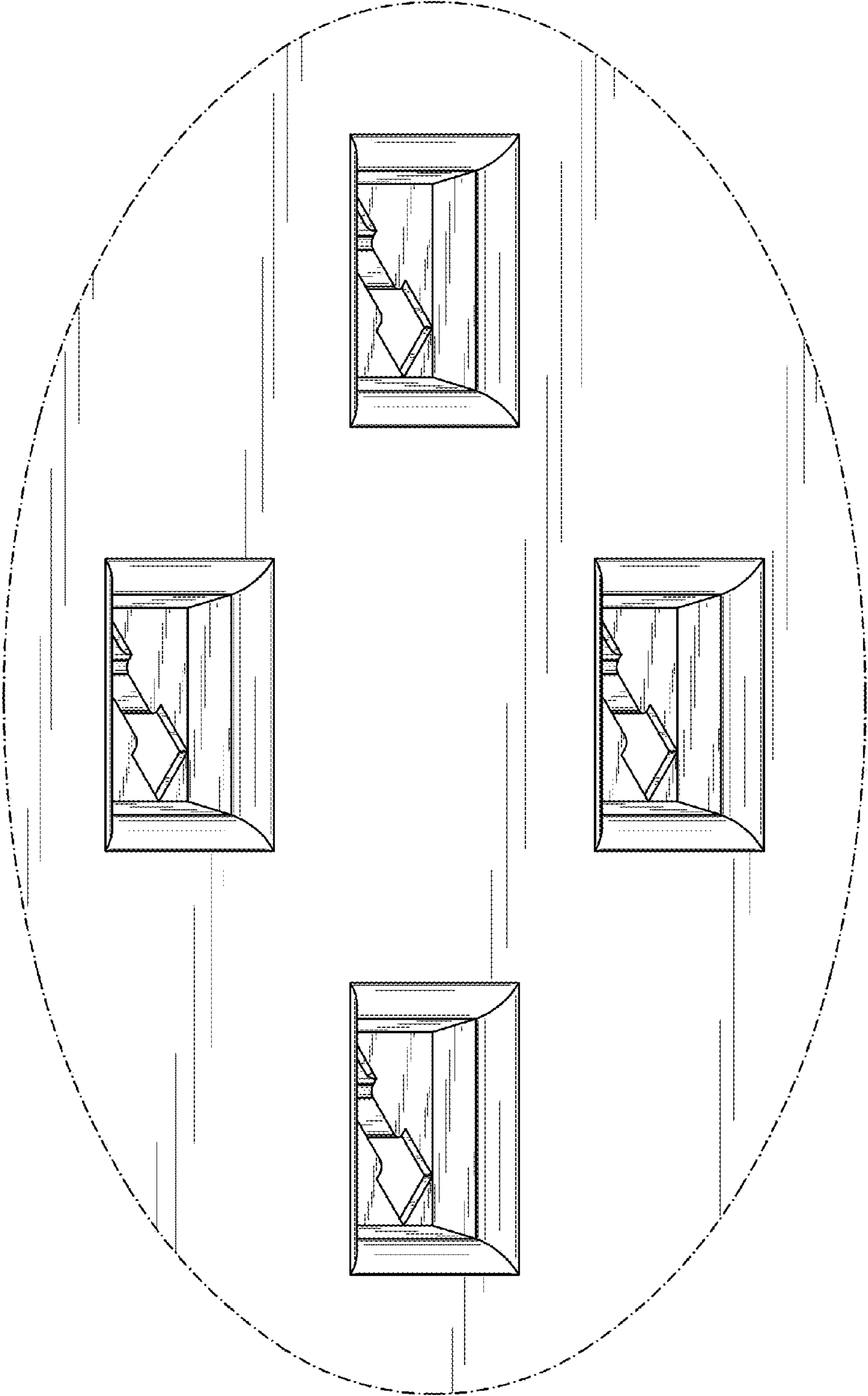


Fig.4



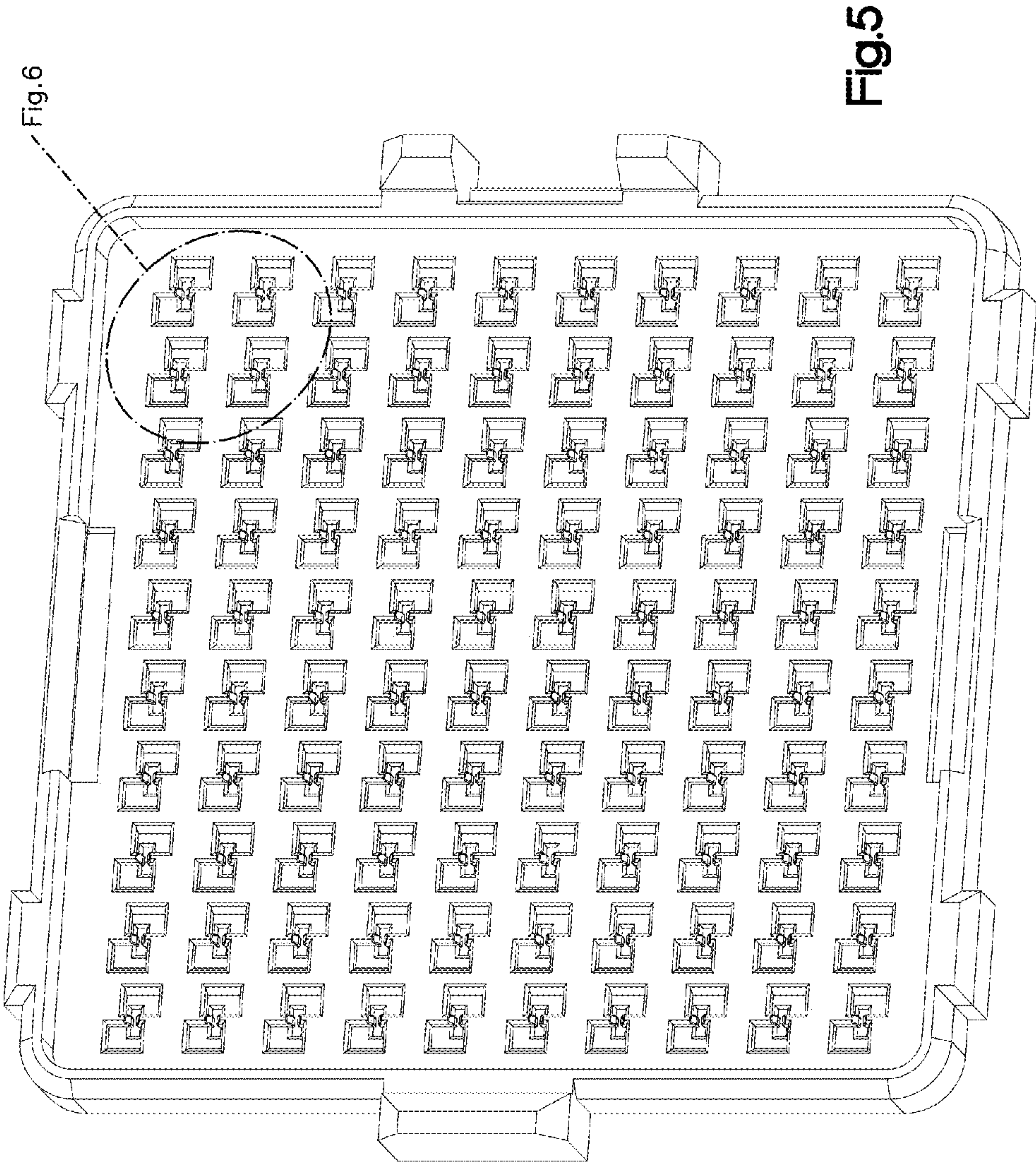


Fig.5

Fig.6



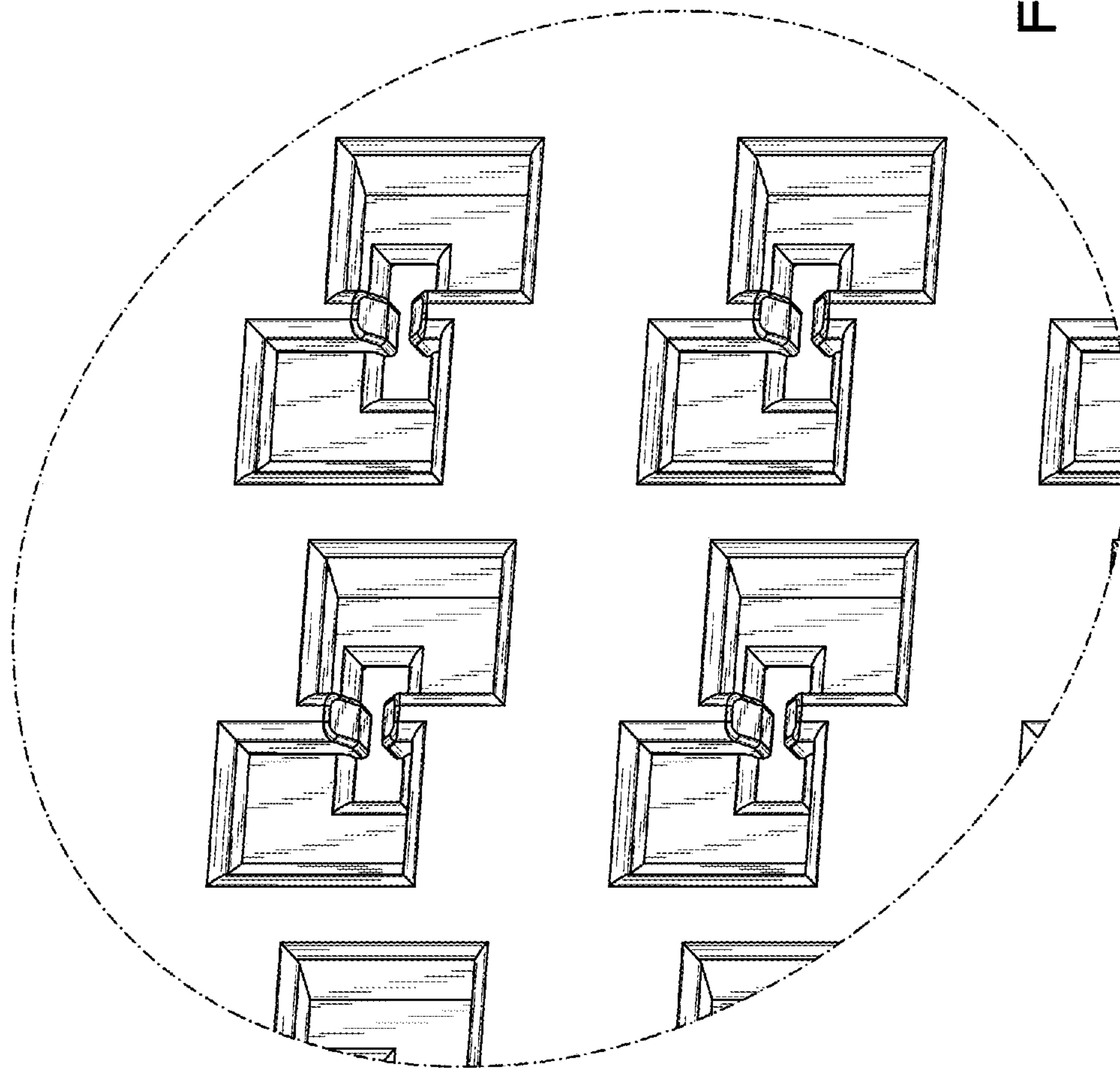


Fig.6



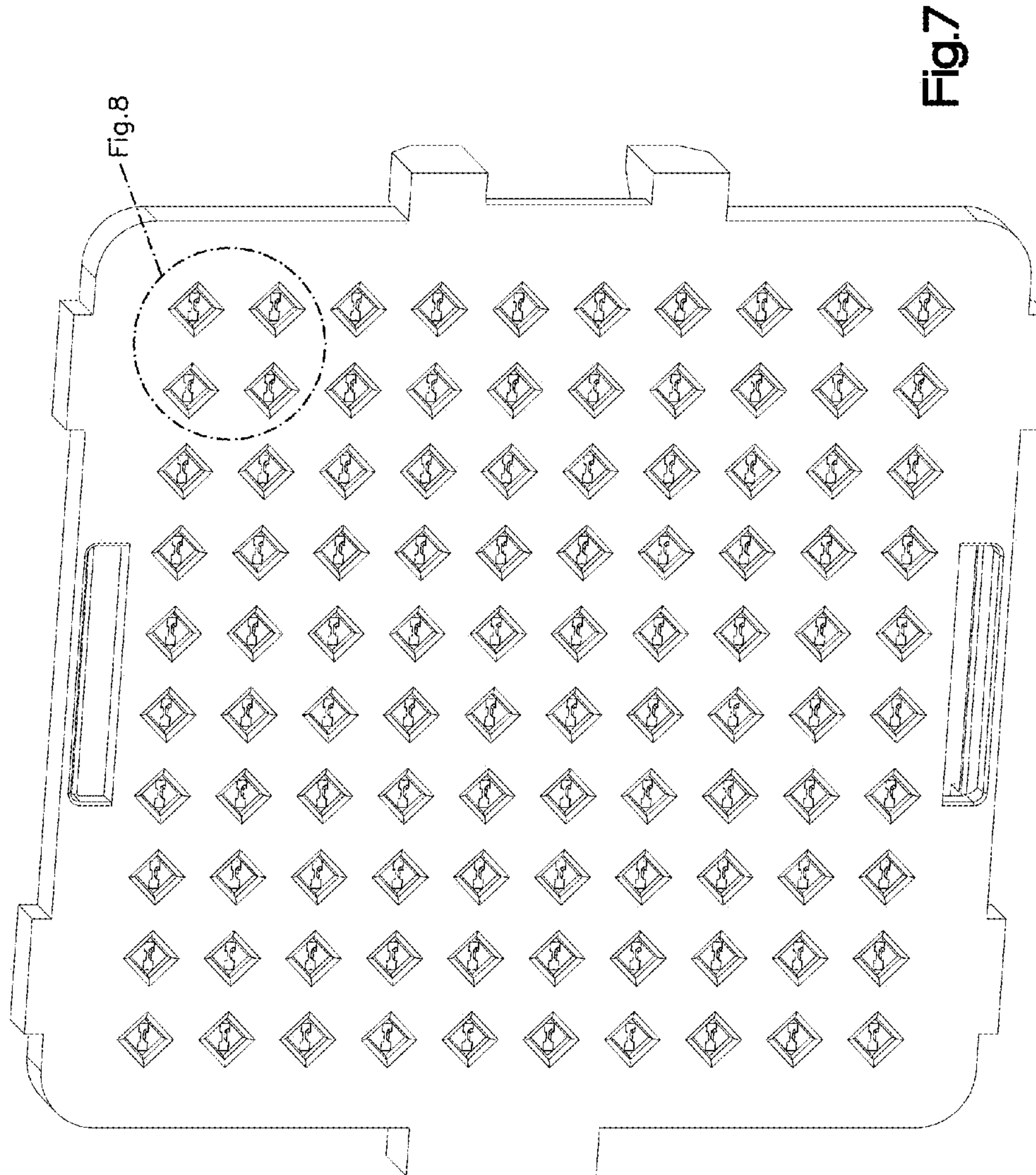


Fig. 7



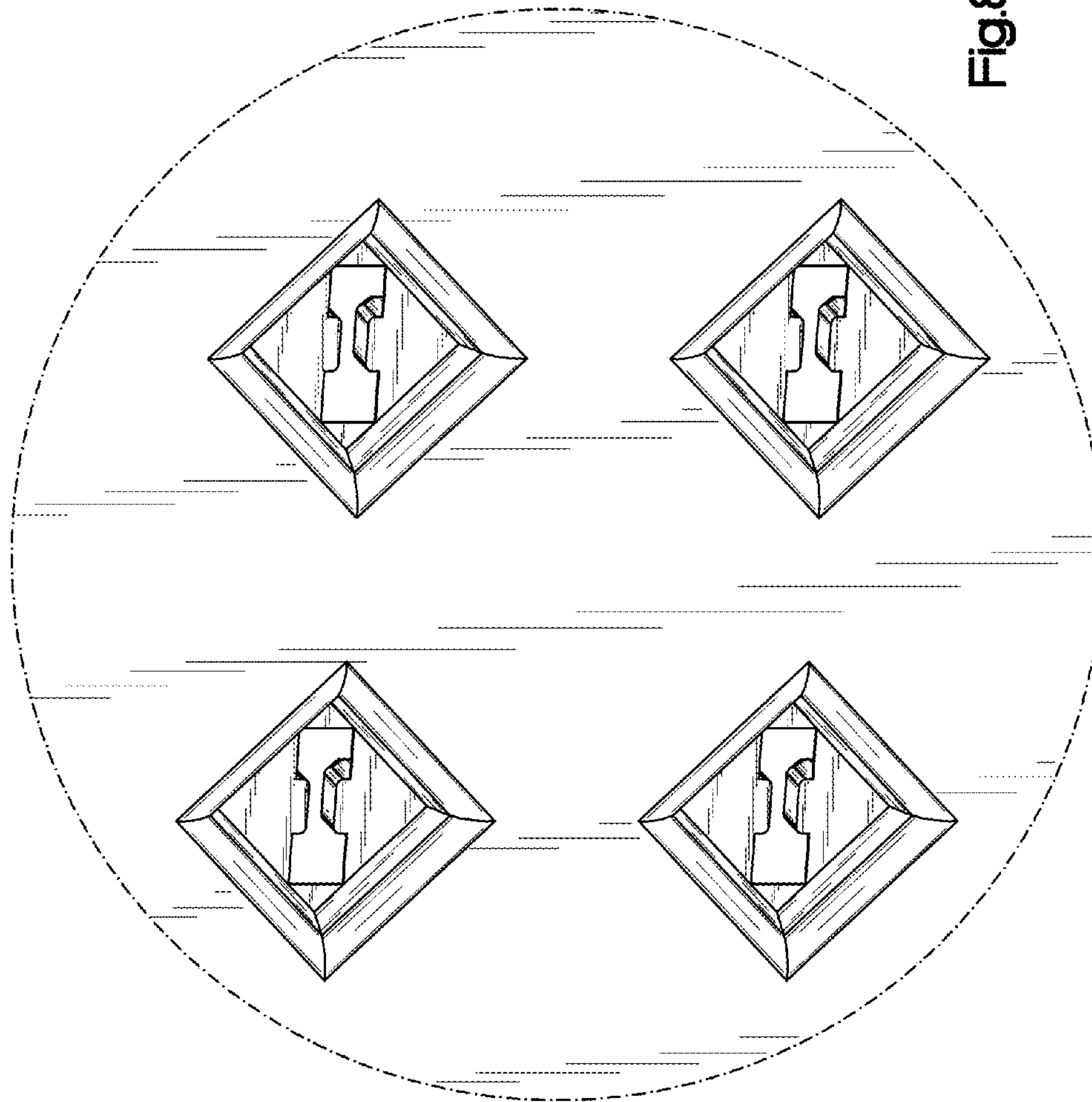


Fig.8

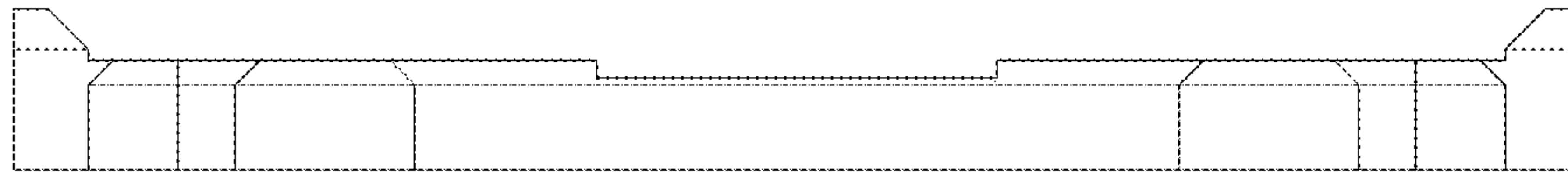


Fig.9

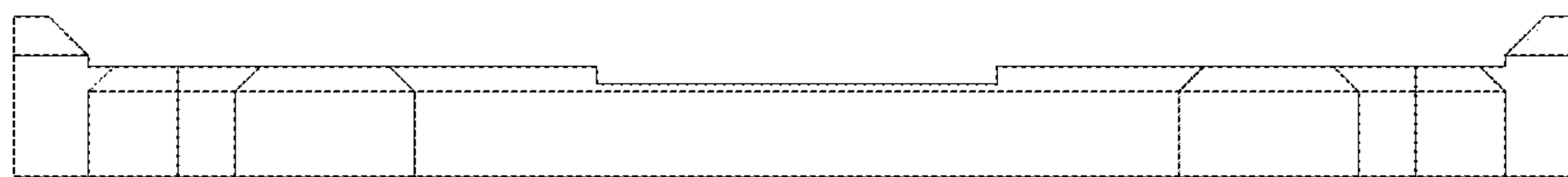


Fig.10

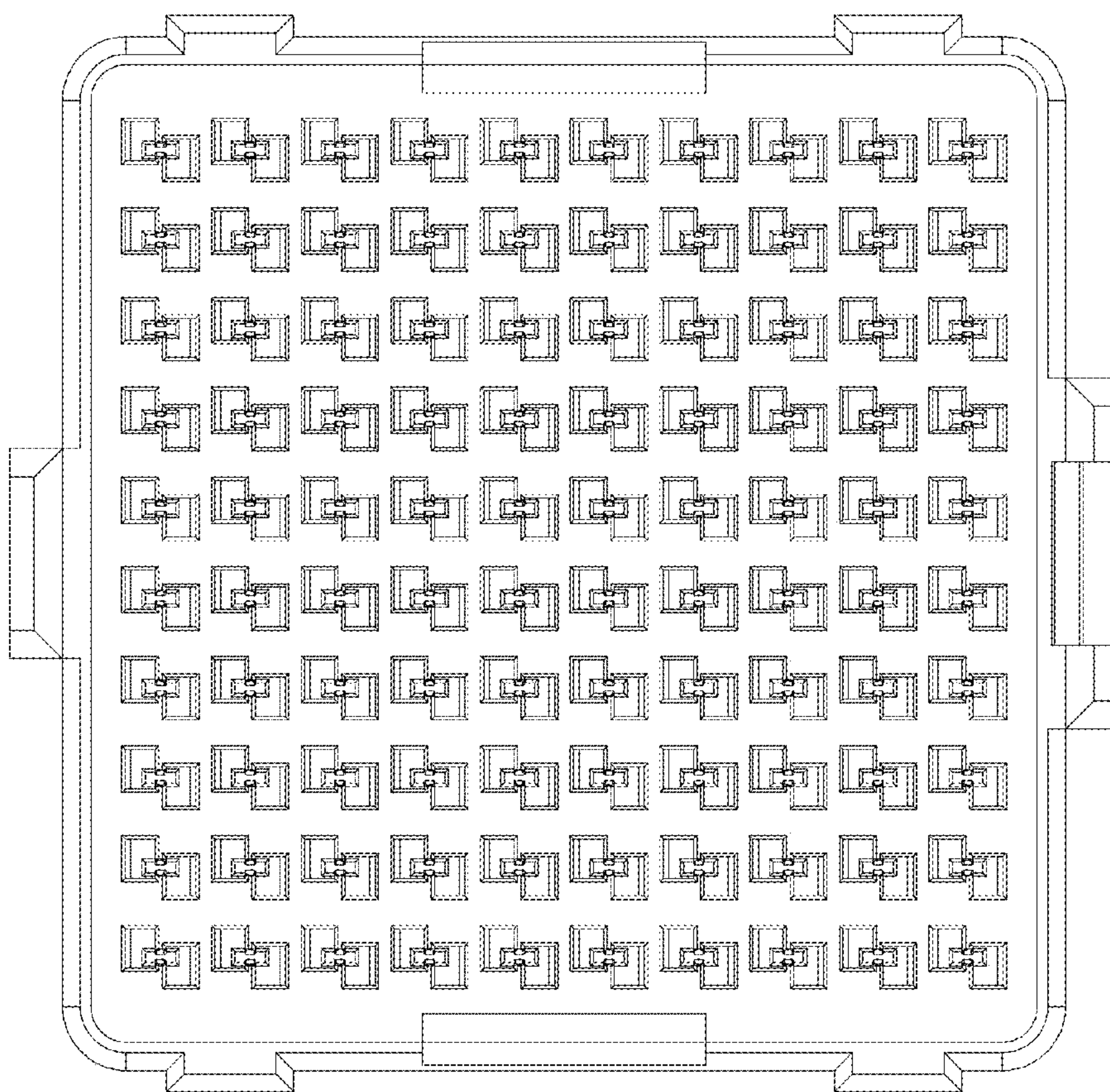


Fig.11



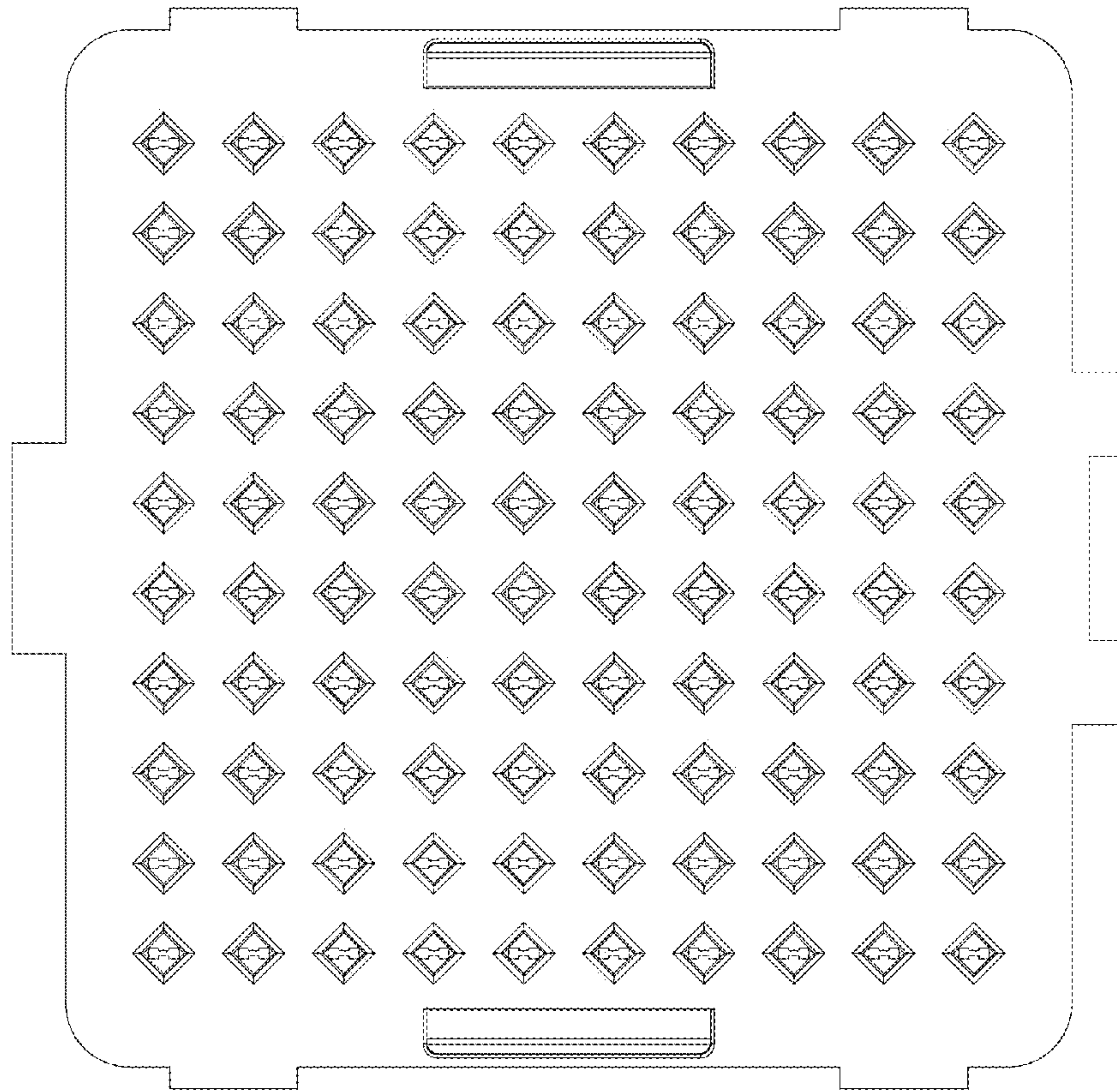


Fig.12

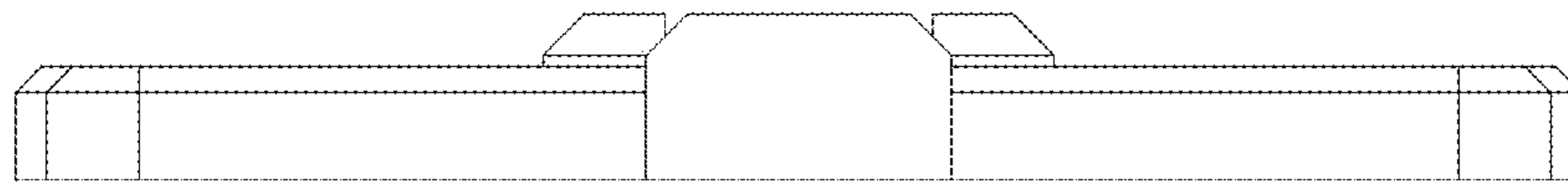


Fig.13

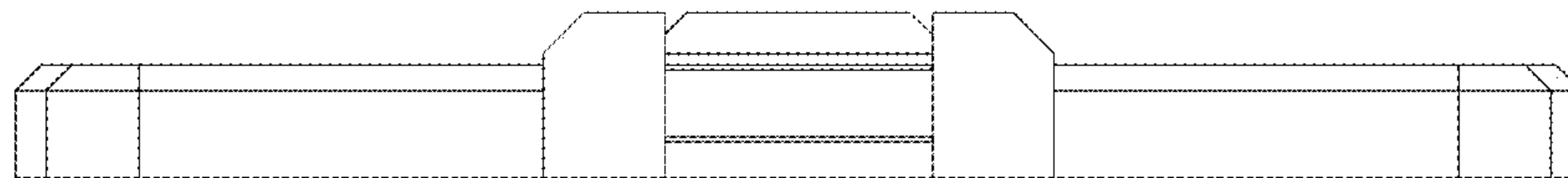


Fig.14